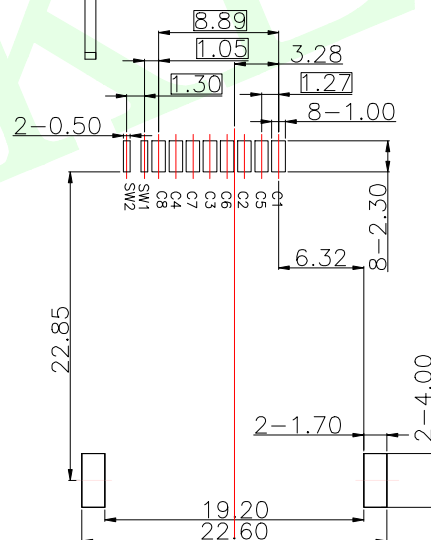
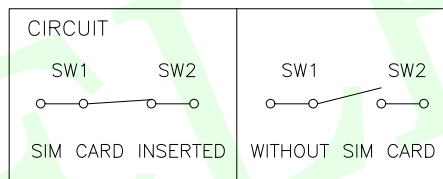
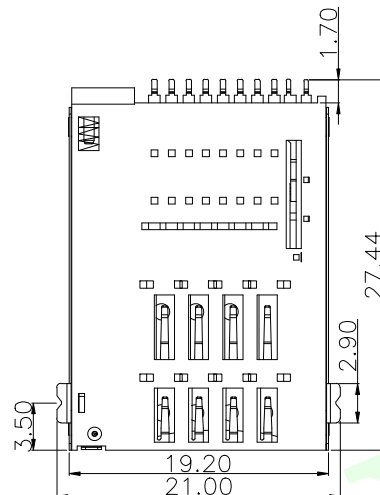
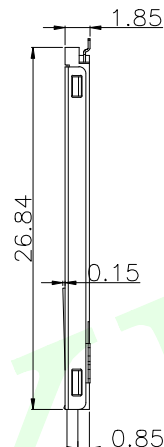
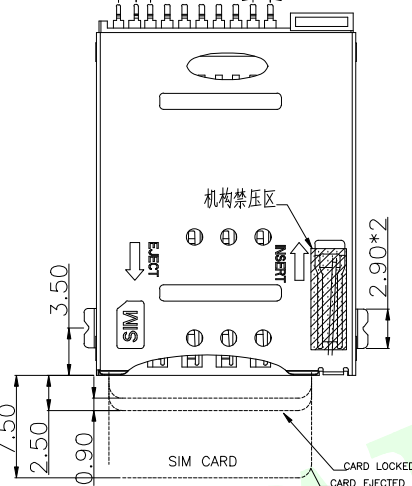
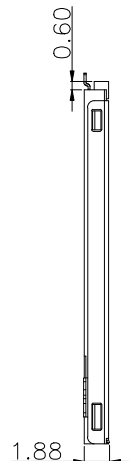
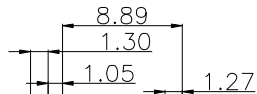
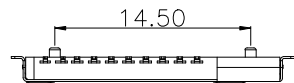
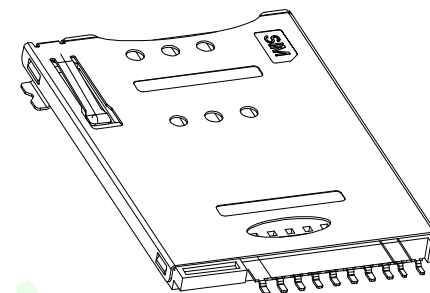


RoHS Compliant



RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05



SPECIFICATION

MATERIAL:

INSULATOR: HIGH TEMPERATURE THERMOPLASTIC,
UL 94V-0. COLOR: BLACK LCP

CONTACT: COPPER ALLOY

PLATING:

CONTACT: PLATED 30U" NI OVERALL

PLATED AU SELECTIVE CONTACT AREA

SHELL: PLATED 30U" NI OVERALL, PAD G/F AU

ELECTRICAL:

CURRENT RATING: 0.5AMPS

VOLTAGE RATING: 5V AC/DC

AMBIENT TEMPERATURE RANGE: $-20^{\circ}\text{C} \sim +60^{\circ}\text{C}$

STORAGE TEMPERATURE RANGE: $-40^{\circ}\text{C} \sim +80^{\circ}\text{C}$

AMBIENT HUMIDITY RANGE: 95% R.H. MAX.

CONTACT RESISTANCE: 100M Ω MAX.

INSULATION RESISTANCE: 1000M Ω MIN./500VDC

MATING CYCLES: 5,000 INSERTIONS

REFLOW PEAK TEMP: 260 $^{\circ}\text{C}$

pin no.	name
C1	vcc of sim
C2	rst of sim
C3	clk of sim
C5	gnd of sim
C6	vpp of sim
C7	I/O of sim
C4/C8	n/a
SW1	switch1
SW2	switch2

连晟欣
LCK

产品类别

MS: MINI SIM

SIM: MICRO SIM

NANO: NANO SIM

产品流水料号识别码

产品高度
H188: 1.88MM

LCK-MS -202 H188 10- W L G

电镀规格
G: gold flash
G1: 1U
G3: 3U
(以此类推)

包装方式
L: 圆盘

有柱无柱
Y: 有柱
W: 无柱

产品PIN位
10: 10PIN

MEASURE POINT:

QUADRANT POINT

TANGENCY POINT

INTERSECTION POINT

QP

TP

IP

UNLESS OTHERWISE
SPECIFIED, TOLERANCE:

X. ± 0.25

X.x ± 0.20

X.xx ± 0.15

ANGULAR $\pm 3^{\circ}$

DESIGN	Andy	DATE	2014.12.24	TITLE:	MINI SIM CARD PUSH PUSH 8+2P
CHECKED		DATE			1.88H SMT 无柱
APPROVED		DATE			
PART NO:	LCK-MS-202H18810-WLG	REV:	04	SCALE:	1:1
DRAWING NO:	102022206	SIZE:	A4	SHEET:	1/1



联晟欣连接器 (深圳) 有限公司
Lianshengxin Connector (Shenzhen) Co., Ltd